

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$	$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
20V	38mΩ@4.5V	5A	-20V	90mΩ@-4.5V	-4A
	45mΩ@2.5V			110mΩ@-2.5V	

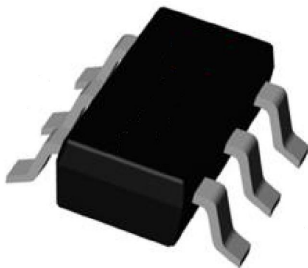
### Feature

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Fast Switching Speed
- Suffix "-Q1" for AEC-Q101

### Application

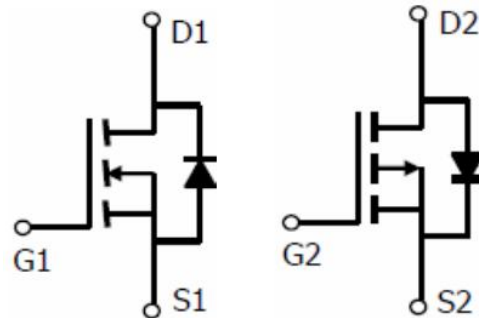
- Motor Control
- Power Management Functions
- DC-DC Converters

### Package

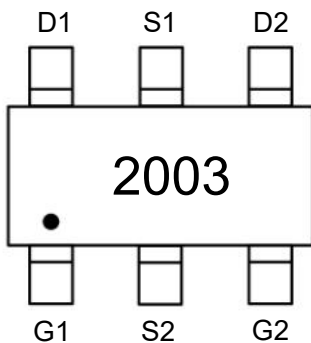


SOT-23-6L

### Circuit diagram



### Marking



### Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	N-Channel	p-Channel	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	±12	V
Continuous Drain Current	I <sub>D</sub>	5	-4	A
Pulsed Drain Current	I <sub>DM</sub>	13	-13	A
Power Dissipation	P <sub>D</sub>	0.8	0.8	W
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	277	277	°C/W
Junction Temperature	T <sub>J</sub>	150	150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	-55 ~ +150	°C

### N-CH Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±12V, V <sub>DS</sub> = 0V			±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.5	0.7	1.0	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4.5A		25	38	mΩ
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 3.5A		35	45	
<b>Dynamic characteristics<sup>1)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 8V, V <sub>GS</sub> = 0V, f = 1MHz		800		pF
Output Capacitance	C <sub>oss</sub>			155		
Reverse Transfer Capacitance	C <sub>rss</sub>			125		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4A		11		nC
Gate-Source Charge	Q <sub>gs</sub>			2.3		
Gate-Drain Charge	Q <sub>gd</sub>			2.5		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10V, V <sub>GS</sub> = 4V, R <sub>G</sub> = 10Ω, I <sub>D</sub> = 1A		18		nS
Turn-on rise time	t <sub>r</sub>			5		
Turn-off delay time	t <sub>d(off)</sub>			43		
Turn-off fall time	t <sub>f</sub>			20		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.7A			1.3	V

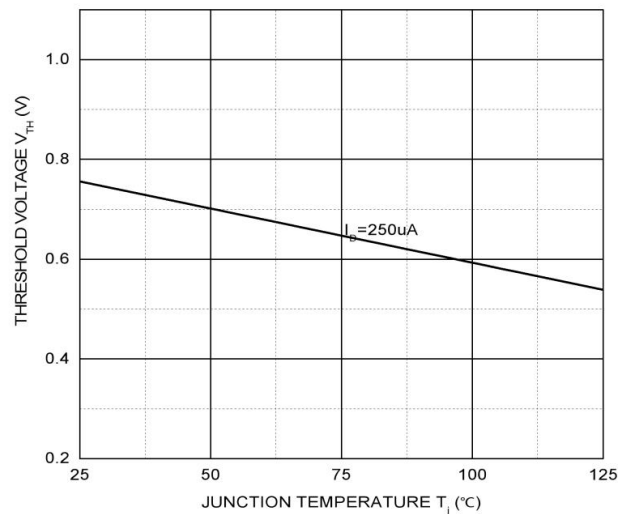
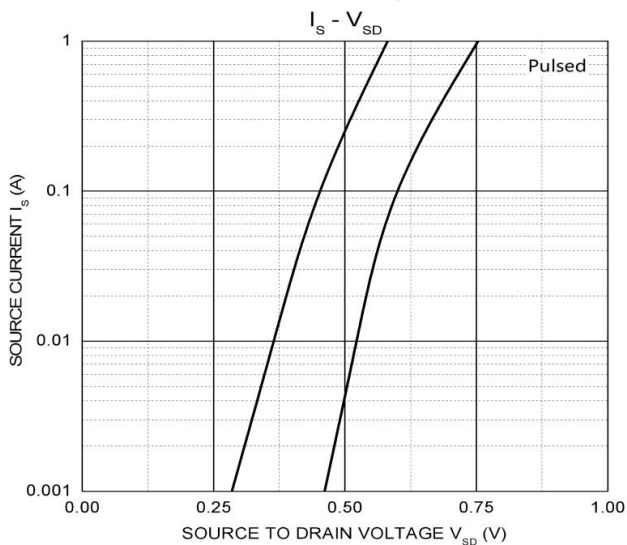
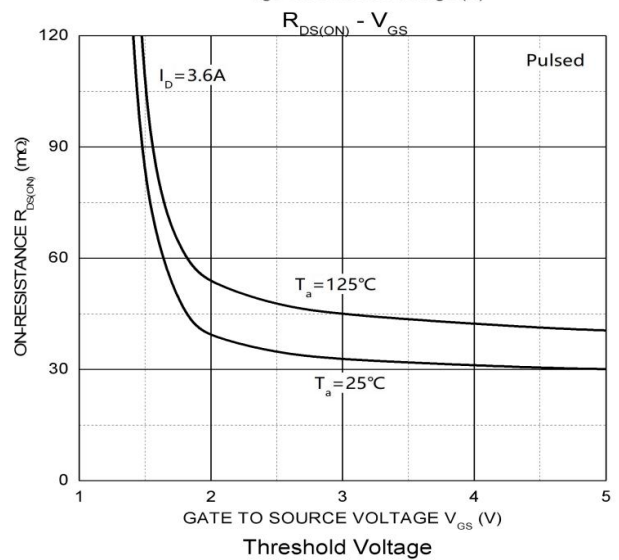
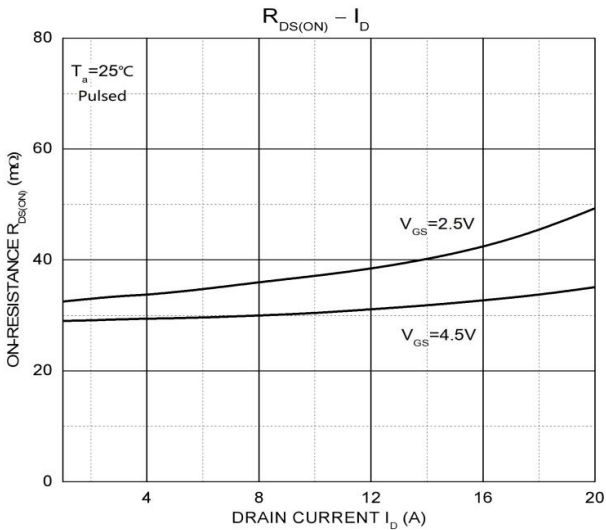
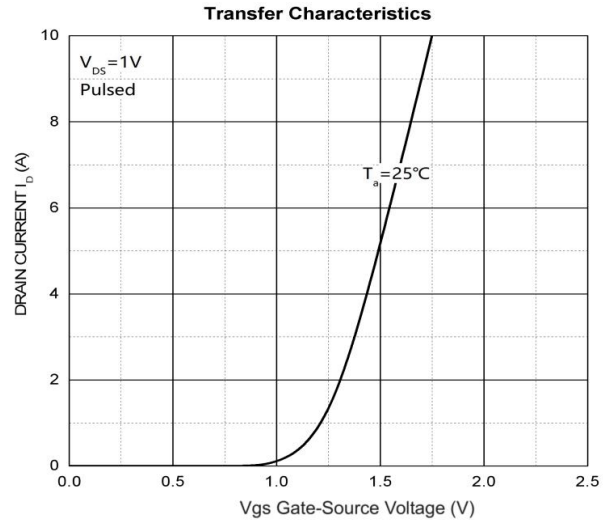
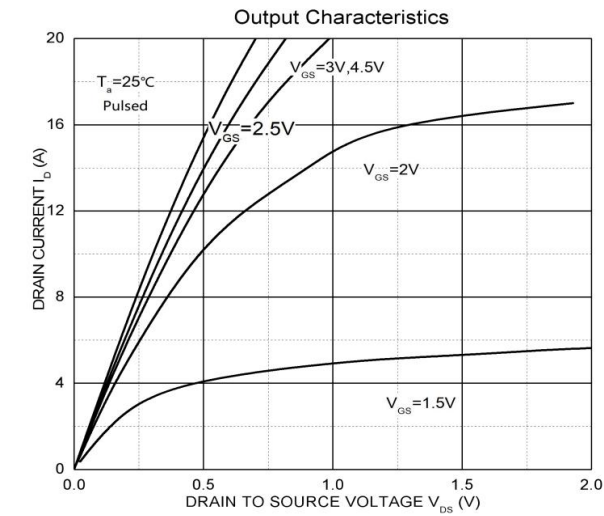
### P-CH Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V			-1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±12V, V <sub>DS</sub> = 0V			±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.5	-0.7	-1.0	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.5A		70	90	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.5A		90	110	
<b>Dynamic characteristics<sup>1)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1MHz		405		pF
Output Capacitance	C <sub>oss</sub>			75		
Reverse Transfer Capacitance	C <sub>rss</sub>			55		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -3A		3.3		nC
Gate-Source Charge	Q <sub>gs</sub>			0.7		
Gate-Drain Charge	Q <sub>gd</sub>			1.3		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = -10V, V <sub>GEN</sub> = -4.5V, R <sub>L</sub> = 10Ω, R <sub>GEN</sub> = 1Ω, I <sub>D</sub> = -1A		11		nS
Turn-on rise time	t <sub>r</sub>			35		
Turn-off delay time	t <sub>d(off)</sub>			30		
Turn-off fall time	t <sub>f</sub>			10		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1.25A			-1.3	V

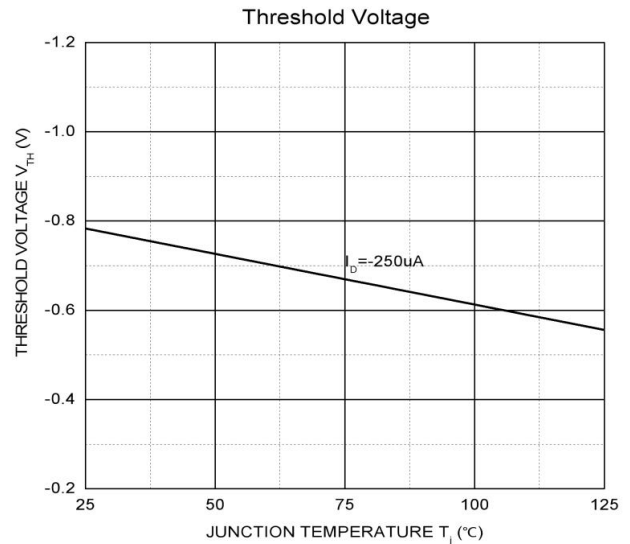
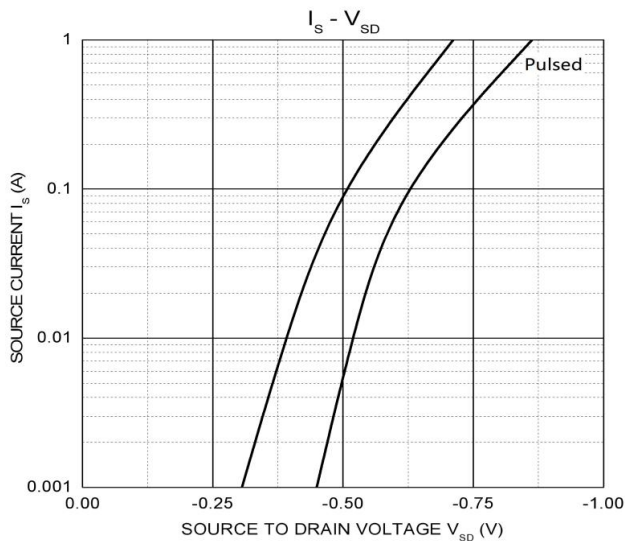
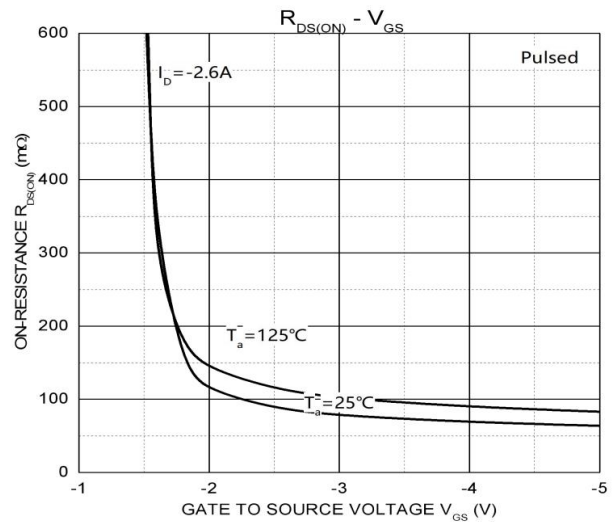
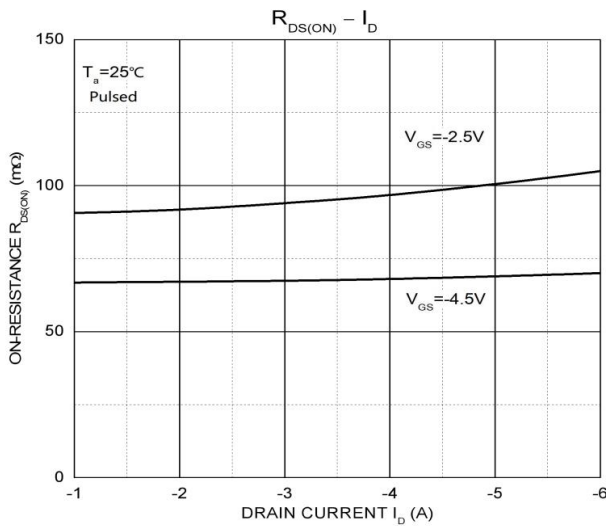
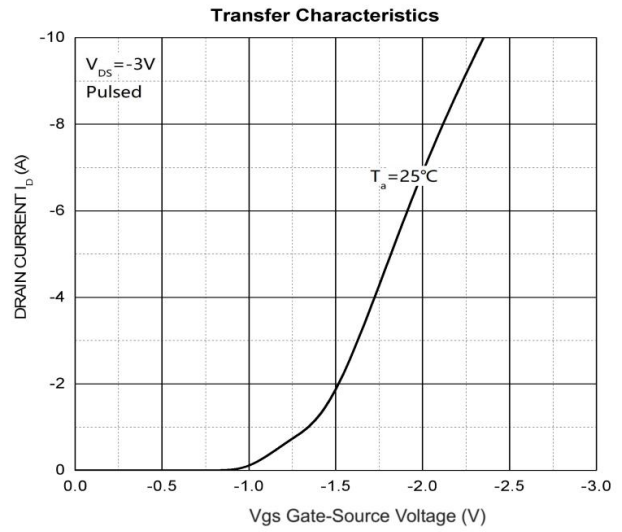
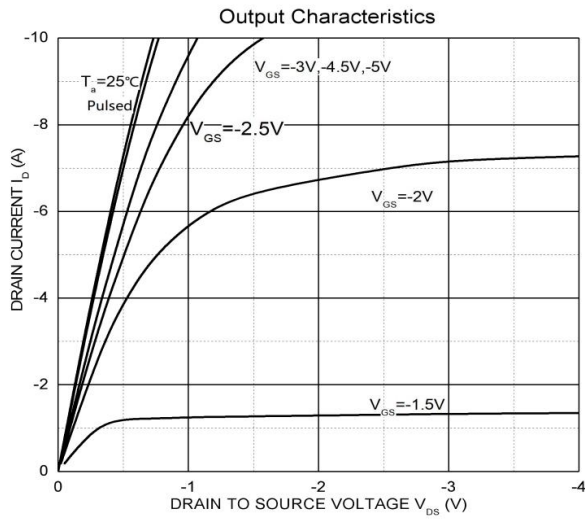
Notes:

1) Guaranteed by design, not subject to production testing.

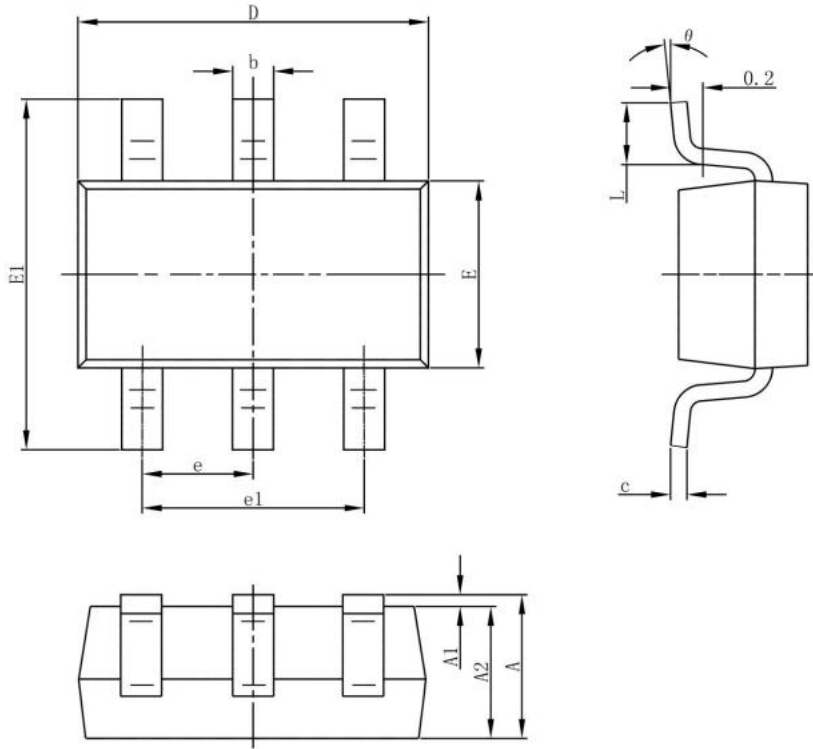
## N- Channel Typical Electrical and Thermal Characteristics (Curves)



## P- Channel Typical Electrical and Thermal Characteristics (Curves)



### SOT-23-6L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	2.650	2.950	0.104	0.116
E	1.500	1.700	0.059	0.067
e	0.950 (BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°